

### General Description

The QM3007J is the highest performance trench P-ch MOSFETs with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The QM3007J meet the RoHS and Green Product requirement with full function reliability approved.

### Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- Green Device Available

### Absolute Maximum Ratings

| Symbol                | Parameter                                    | Rating     | Units      |
|-----------------------|--|------------|------------|
| $V_{DS}$              | Drain-Source Voltage                         | -30        | V          |
| $V_{GS}$              | Gate-Source Voltage                          | $\pm 20$   | V          |
| $I_D@T_C=25^\circ C$  | Continuous Drain Current, $-V_{GS} @ -10V^1$ | -6         | A          |
| $I_D@T_C=100^\circ C$ | Continuous Drain Current, $-V_{GS} @ -10V^1$ | -4.6       | A          |
| $I_{DM}$              | Pulsed Drain Current <sup>2</sup>            | -12        | A          |
| $P_D@T_C=25^\circ C$  | Total Power Dissipation <sup>3</sup>         | 3.47       | W          |
| $T_{STG}$             | Storage Temperature Range                    | -55 to 150 | $^\circ C$ |
| $T_J$                 | Operating Junction Temperature Range         | -55 to 150 | $^\circ C$ |

### Thermal Data

| Symbol          | Parameter  | Typ. | Max. | Unit         |
|-----------------|--|------|------|--------------|
| $R_{\theta JA}$ | Thermal Resistance Junction-Ambient <sup>1</sup> | ---  | 85   | $^\circ C/W$ |
| $R_{\theta JC}$ | Thermal Resistance Junction-Case <sup>1</sup>    | ---  | 36   | $^\circ C/W$ |

### Product Summary

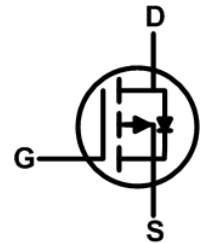
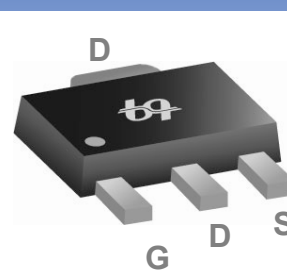


| BVDSS | RDSON        | ID  |
|-------|--------------|-----|
| -30V  | 70m $\Omega$ | -6A |

### Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

### SOT89 Pin Configuration



**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**

| Symbol                       | Parameter                                      | Conditions  | Min. | Typ.  | Max.      | Unit                 |
|------------------------------|--|---|------|-------|-----------|----------------------|
| $BV_{DSS}$                   | Drain-Source Breakdown Voltage                 | $V_{GS}=0V, I_D=-250\mu A$                          | -30  | ---   | ---       | V                    |
| $\Delta BV_{DSS}/\Delta T_J$ | BVDSS Temperature Coefficient                  | Reference to $25^\circ\text{C}$ , $I_D=-1\text{mA}$ | ---  | -0.02 | ---       | V/ $^\circ\text{C}$  |
| $R_{DS(ON)}$                 | Static Drain-Source On-Resistance <sup>2</sup> | $V_{GS}=-10V, I_D=-3A$                              | ---  | 55    | 70        | m $\Omega$           |
|                              |  | $V_{GS}=-4.5V, I_D=-1.5A$                           | ---  | 90    | 120       |                      |
| $V_{GS(th)}$                 | Gate Threshold Voltage                         | $V_{GS}=V_{DS}, I_D=-250\mu A$                      | -1.0 | -1.5  | -2.5      | V                    |
| $\Delta V_{GS(th)}$          | $V_{GS(th)}$ Temperature Coefficient           |   | ---  | 4.32  | ---       | mV/ $^\circ\text{C}$ |
| $I_{DSS}$                    | Drain-Source Leakage Current                   | $V_{DS}=-24V, V_{GS}=0V, T_J=25^\circ\text{C}$      | ---  | ---   | -1        | $\mu\text{A}$        |
|                              |  | $V_{DS}=-24V, V_{GS}=0V, T_J=55^\circ\text{C}$      | ---  | ---   | -5        |                      |
| $I_{GSS}$                    | Gate-Source Leakage Current                    | $V_{GS}=\pm 20V, V_{DS}=0V$                         | ---  | ---   | $\pm 100$ | nA                   |
| $g_{fs}$                     | Forward Transconductance                       | $V_{DS}=-5V, I_D=-3A$                               | ---  | 5.5   | ---       | S                    |
| $R_g$                        | Gate Resistance                                | $V_{DS}=0V, V_{GS}=0V, f=1\text{MHz}$               | ---  | 24    | 48        | $\Omega$             |
| $Q_g$                        | Total Gate Charge (-4.5V)                      | $V_{DS}=-20V, V_{GS}=-4.5V, I_D=-5A$                | ---  | 5.22  | ---       | nC                   |
| $Q_{gs}$                     | Gate-Source Charge                             |   | ---  | 1.25  | ---       |                      |
| $Q_{gd}$                     | Gate-Drain Charge                              |   | ---  | 2.3   | ---       |                      |
| $T_{d(on)}$                  | Turn-On Delay Time                             | $V_{DD}=-15V, V_{GS}=-10V, R_G=3.3\Omega, I_D=-1A$  | ---  | 18.4  | ---       | ns                   |
| $T_r$                        | Rise Time                                      |   | ---  | 11.4  | ---       |                      |
| $T_{d(off)}$                 | Turn-Off Delay Time                            |   | ---  | 39.4  | ---       |                      |
| $T_f$                        | Fall Time                                      |   | ---  | 5.2   | ---       |                      |
| $C_{iss}$                    | Input Capacitance                              | $V_{DS}=-15V, V_{GS}=0V, f=1\text{MHz}$             | ---  | 463   | ---       | pF                   |
| $C_{oss}$                    | Output Capacitance                             |   | ---  | 82    | ---       |                      |
| $C_{riss}$                   | Reverse Transfer Capacitance                   |   | ---  | 68    | ---       |                      |

**Diode Characteristics**

| Symbol   | Parameter                                | Conditions                                 | Min. | Typ. | Max. | Unit |
|----------|--|--|------|------|------|------|
| $I_S$    | Continuous Source Current <sup>1,4</sup> | $V_G=V_D=0V$ , Force Current               | ---  | ---  | -6   | A    |
| $I_{SM}$ | Pulsed Source Current <sup>2,4</sup>     |  | ---  | ---  | -12  | A    |
| $V_{SD}$ | Diode Forward Voltage <sup>2</sup>       | $V_{GS}=0V, I_S=-1A, T_J=25^\circ\text{C}$ | ---  | ---  | -1   | V    |

Note :

- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$
- 3.The power dissipation is limited by  $150^\circ\text{C}$  junction temperature
- 4.The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications , should be limited by total power dissipation.

### Typical Characteristics

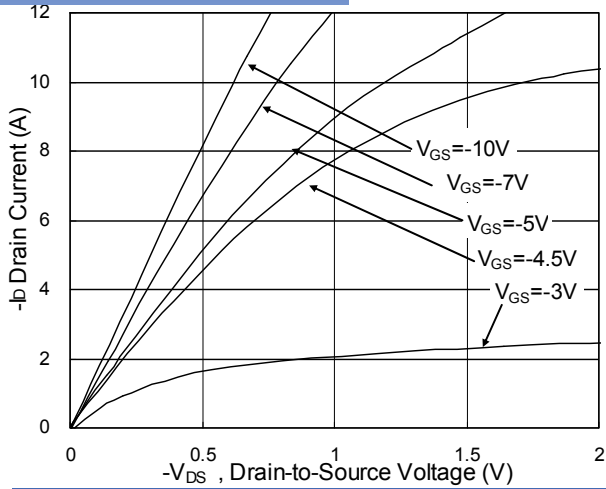


Fig.1 Typical Output Characteristics

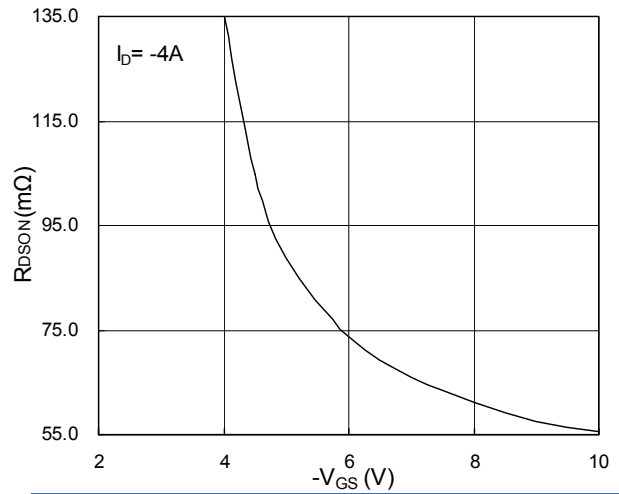


Fig.2 On-Resistance vs. G-S Voltage

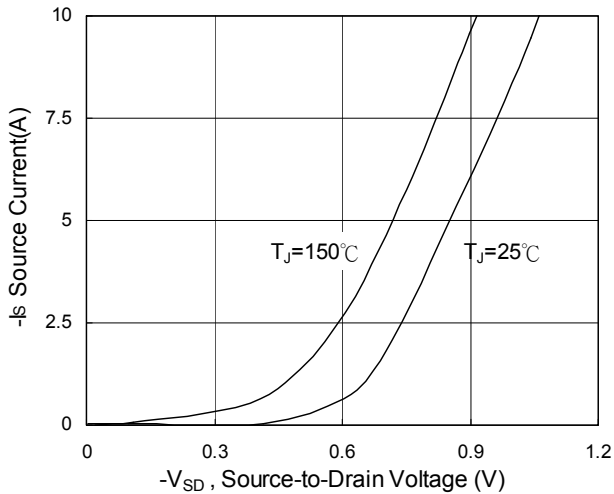


Fig.3 Forward Characteristics of Reverse

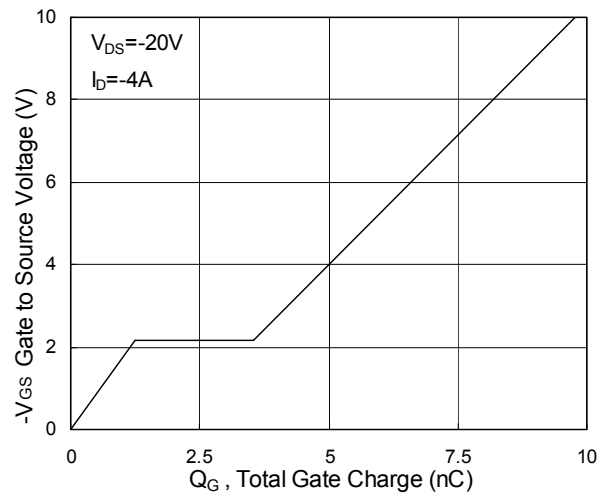


Fig.4 Gate-Charge Characteristics

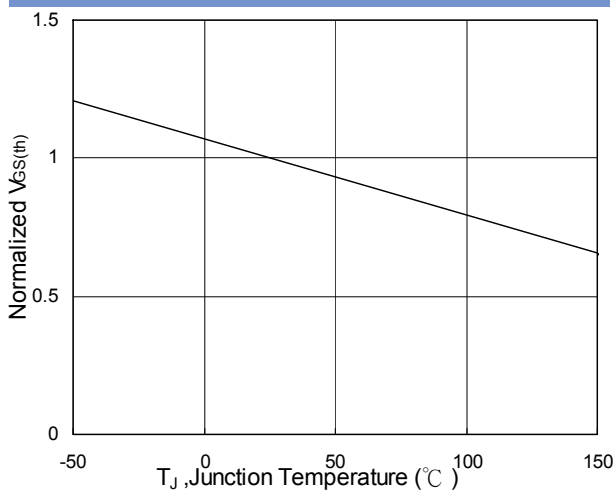


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$

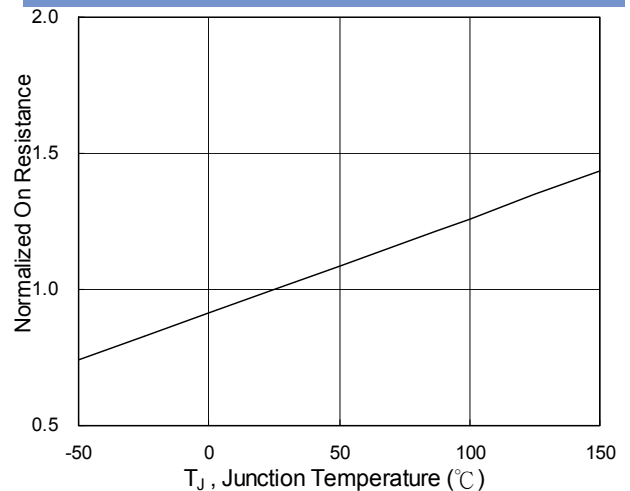


Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$

## P-Ch 30V Fast Switching MOSFETs

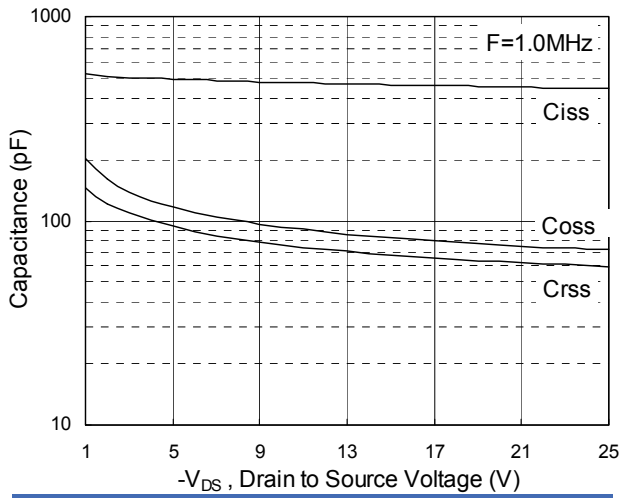


Fig.7 Capacitance

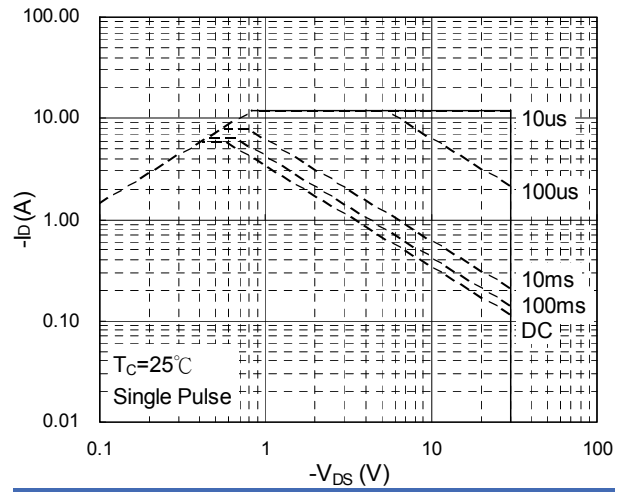


Fig.8 Safe Operating Area

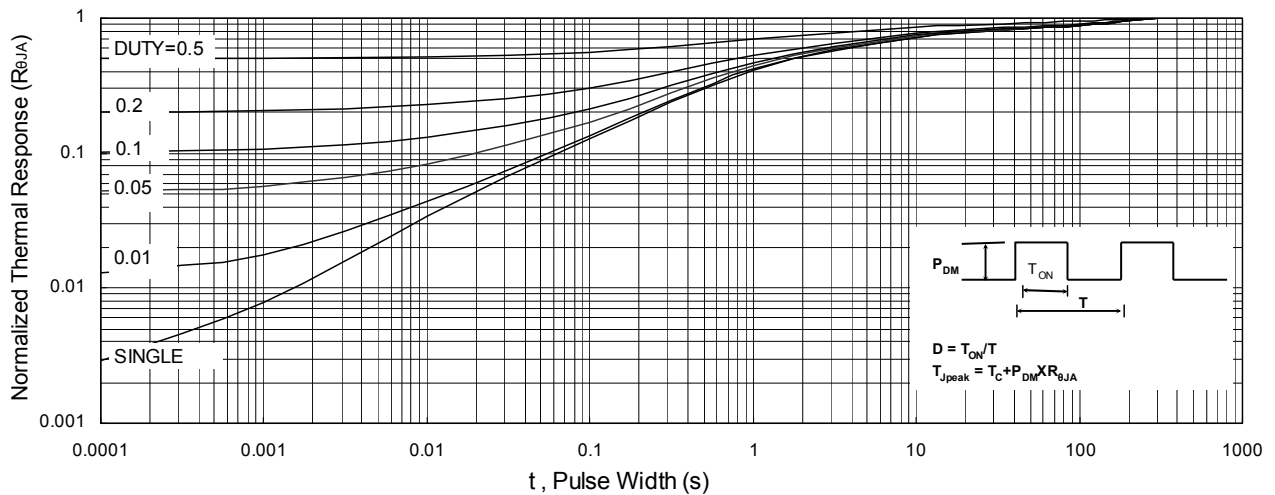


Fig.9 Normalized Maximum Transient Thermal Impedance

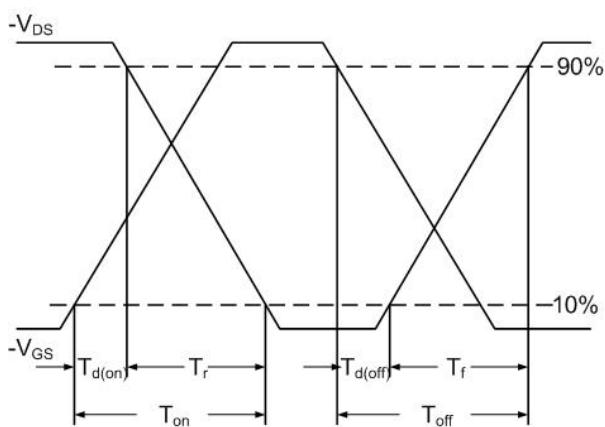


Fig.10 Switching Time Waveform

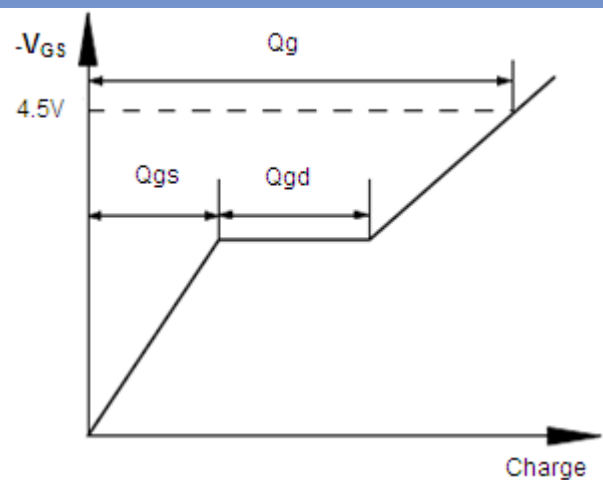


Fig.11 Gate Charge Waveform